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M16C/62P Group

Operation of Timer B (pulse period measurement mode)

1. Abstract

In pulse period/pulse width measurement mode, choose functions from those listed in Table 1. Operations of the circled items are described below. Figure 1 shows the operation timing, and Figure 2 shows the set-up procedure. A reference program is an example when using the Timer B0 interrupt based on the setting procedure of Figure 2.

2. Introduction

This application note is applied to the M16C/62P group Microcomputers.

This program can be operated under the condition of M16C family products with the same SFR(Special Function Register) as M16C/62P Group products. Because some functions may be modified of the M16C family products, see the user's manual. When using the functions shown in this application note, evaluate them carefully for an operation

3. Choosed functions

Table 1. Choosed functions

Item	Set-up	
Count source	O	Internal count source (f1 / f8 / f32 / fc32)
Measurement mode	O	Pulse period measurement (interval between measurement pulse falling edge to falling edge)
		Pulse period measurement (interval between measurement pulse rising edge to rising edge)
		Pulse width measurement (interval between measurement pulse falling edge to rising edge, and between rising edge to falling edge)

4. Operation

(1) Setting the count start flag to “1” causes the counter to start counting the count source.
(2) If a measurement pulse changes from “H” to “L”, the value of the counter goes to “0000h”, and measurement is started. In this instance, an indeterminate value is transferred to the reload register. The timer Bi interrupt request does not generate.
(3) If a measurement pulse changes from “H” to “L” again, the value of the counter is transferred to the reload register, and the timer Bi interrupt request bit goes to “1”. Then the value of the counter becomes “0000h”, and the measurement is started again.

Note

- The timer Bi interrupt request bit goes to “1” when an effective edge of a measurement pulse is input or timer Bi is overflowed. The factor of interrupt request can be determined by use of the timer Bi overflow flag within the interrupt routine.
- The value of the counter at the beginning of a count is indeterminate. Therefore, the timer Bi overflow flag may go to “1” and timer Bi interrupt request may be generated during the interval between a count start and an effective edge input.
- The timer Bi overflow flag is indeterminate after reset. The timer Bi overflow flag goes to “0” if timer Bi mode register is written to when the count start flag is “1”. This flag cannot be set to “1” by software.

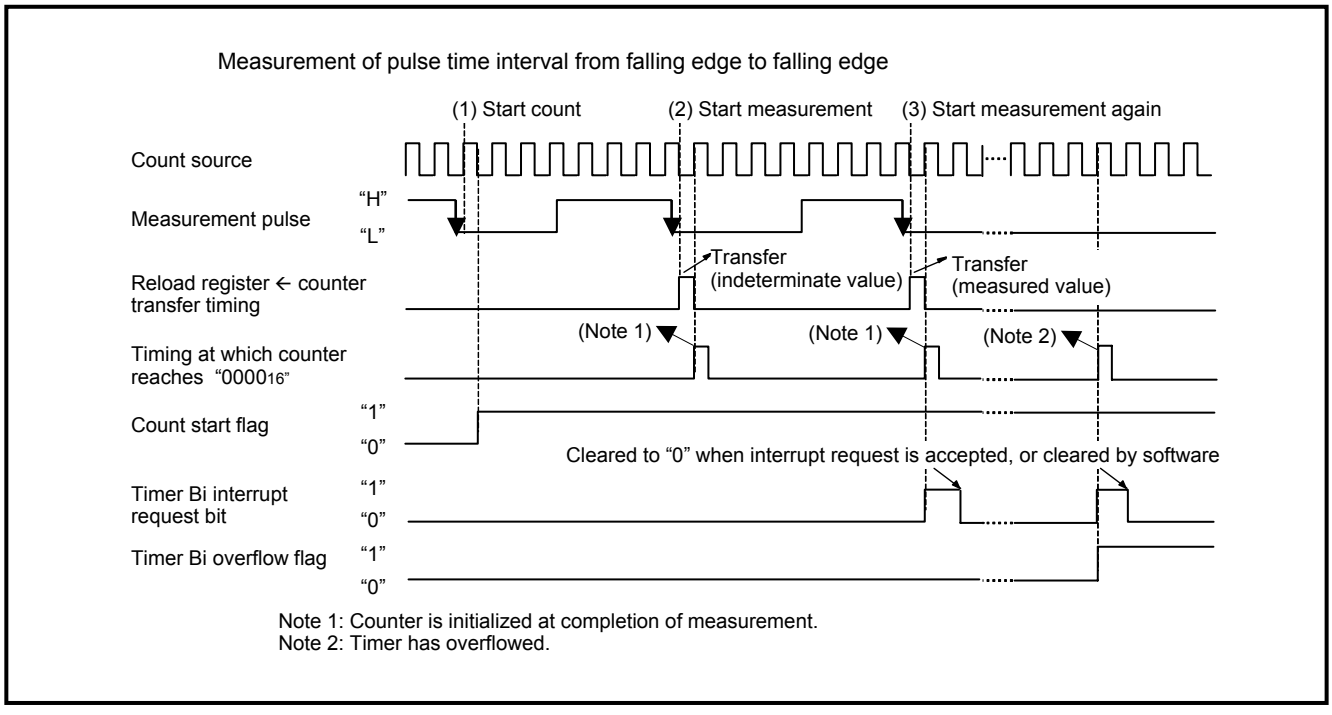

Figure 1. Operation timing of pulse period measurement mode

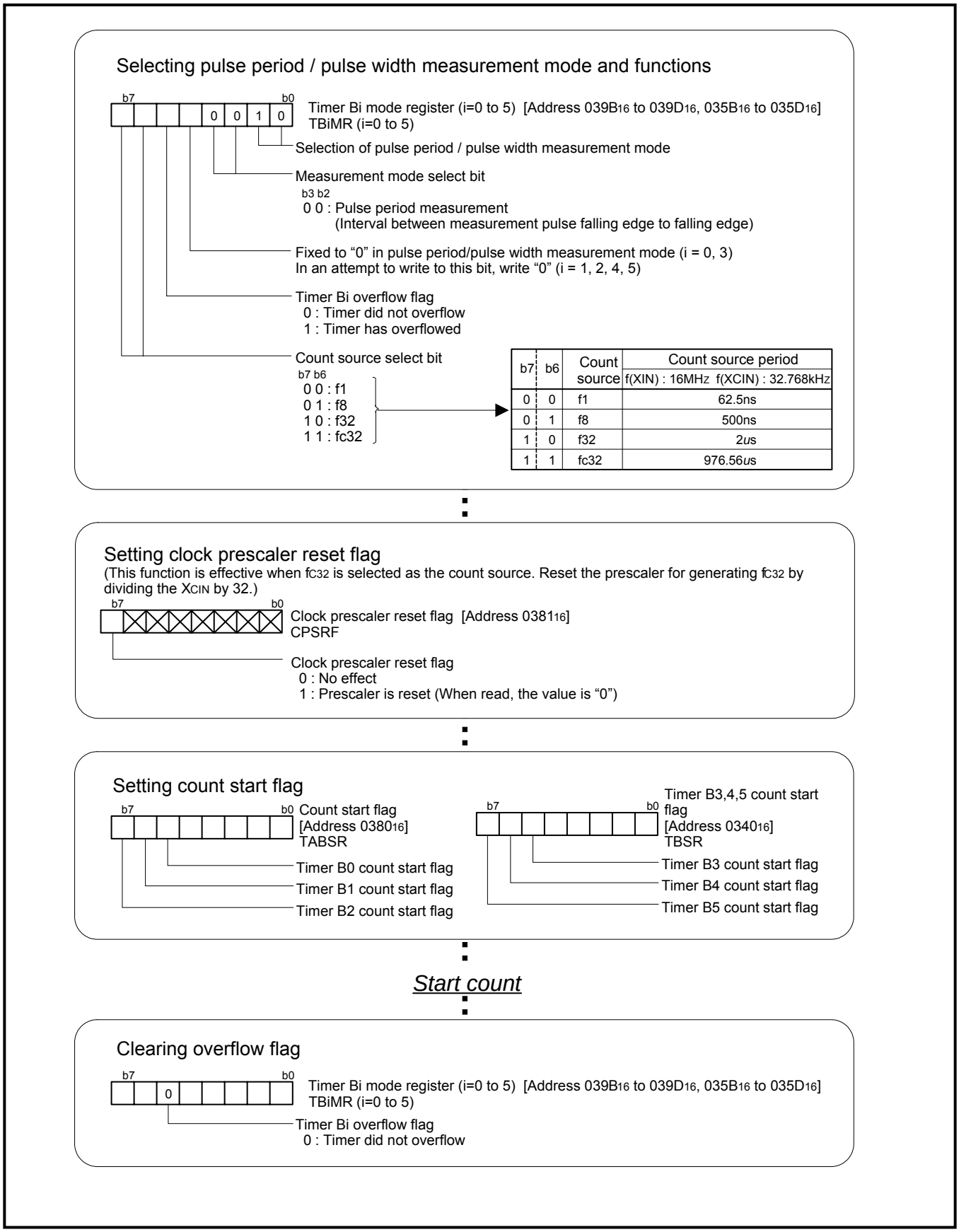

Figure 2. set-up procedure of pulse period measurement mode

5. The example of reference program

```
;***************************************************************************
;
;    M16C/62P Program Collection
;
;    FILE NAME : rjj05b0704_src.a30
;    CPU       : M16C/62P Group
;    FUNCTION  : Operation of Timer B (pulse period measurement mode)
;    HISTORY   : 2004.12.24   Ver 1.00
;              : 2006.1.25    Ver 1.10
;
;    Copyright(C)2006, Renesas Technology Corp.
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;
;***************************************************************************
;***************************************************************************
;        Include
;***************************************************************************
;
        .LIST       off                 ;Stops outputting lines to the assembler list file
        .INCLUDE    sfr62p.inc          ;Reads the file that defined SFR
        .LIST       on                  ;Starts outputting lines to the assembler list file
;
;***************************************************************************
;        Symbol definition
;***************************************************************************
;
RAM_TOP             .equ    00400h      ;Start address of RAM
RAM_END             .equ    013ffh      ;End address of RAM
ROM_TOP             .equ    0f4000h     ;Start address of ROM
VECT_TOP            .equ    0ffe00h     ;Start address of vect_top
FIXED_VECT_TOP      .equ    0fffdch     ;Start address of fixed_vect_top
SB_BASE             .equ    00380h      ;Base address of sb
;
;***************************************************************************
;        Program area
;***************************************************************************
;=========================================================================
;        Start up
;=========================================================================
;
            .section   program,code     ;Declares section name and section type
            .org       ROM_TOP          ;Declares start address
            .sb        SB_BASE          ;
;
```

```
START:
                ldc         #RAM_END+1,isp ;Sets interrupt stack pointer
                ldc         #SB_BASE,sb    ;Sets sb register
;
                mov.b       #03h,prcr      ;Removes protect
                                           ;Set processor mode registers 0 and 1
                mov.w       #0800h,pm0     ;Single-chip mode
                                           ;No expansion, No wait
                mov.w       #2008h,cm0     ;Xcin-Xcout High
                                           ;Xin-Xout High, Main clock is No divison
                mov.b       #0,prcr        ;Protects all registers
;
                ldintb      #VECT_TOP      ;Sets interrupt table register

                mov.w       #0,r0          ;Clears WORKRAM area
                mov.w       #((RAM_END+1)-RAM_TOP)/2,r3
                mov.w       #RAM_TOP,a1
                sstr.w
;
;===============================================================================
;       Main program
;===============================================================================
                mov.b       #01000010b,tb0mr ;Timer B0 mode register
;                             | | | | | ++----------;Pulse period/pulsewidgh measurement mode
;                             | | | | ++----------;Pulse period measurement (measurement between
;                             | | | |              ;a falling adge ;and the next falling adge of measured
;                             | | | |              ;pulse)
;                             | | | +-------------;Set to“0”in pulse period and pulse widge measurement
;                             | | |                ;mode
;                             | | +---------------;Timer has not overflowed
;                             ++-------------------;Count source(f8)
                mov.b       #00000011b,tb0ic   ;Interrupt control register
;                                    |+++---------;Interrupt priority level select bit
;                                    |            ;(011:Level 3, interrupt disabled)
;                                    +------------;Interrupt request bit (0:interrupt not requested)
                mov.b       #00100000b,tabsr  ;Count start flag
;                                  +------------;Starts counting
                nop                            ;To set the MR3 bit to “0” (no overflow), set TBiMR
                nop                            ;register with setting the TBiS bit to “1” and counting the
                nop                            ;next count source after setting the MR3 bit to “1”
                nop                            ;(overflow). Newly added in the Ver 1.10
                nop                            ;
                nop                            ;
                nop                            ;
                nop                            ;
```

```
                fset        i                   ;Set interrupt enable flag
                mov.b       #01000010b,tb0mr ;Timer B0 mode register
;                                 +-----------------;Timer did not overflowed
MAIN:

                jmp         MAIN
;===============================================================================
;       Interrupt program
;===============================================================================
TB0_INT:
;
;               ;/ TB0 interrupt routine /
;
                reit
;
;===============================================================================
;       Dummy interrupt processing program
;===============================================================================
DUMMY:
                reit
;
;*******************************************************************************
;       Setting of variable vector table
;*******************************************************************************
;
                .section   vect,romdata
                .org       VECT_TOP + (4 * 4)
;
                .lword     DUMMY        ;INT3 interrupt vector
                .lword     DUMMY        ;TB5 interrupt vector
                .lword     DUMMY        ;TB4 interrupt vector
                                        ;UART1 bus collision detection interrupt vector
                .lword     DUMMY        ;TB3 interrupt vector
                                        ;UART0 bus collision detection interrupt vector
                .lword     DUMMY        ;SI/04/INT5 interrupt vector
                .lword     DUMMY        ;SI/03/INT4 interrupt vector
                .lword     DUMMY        ;UART2 bus collision detection interrupt vector
                .lword     DUMMY        ;DMA0 interrupt vector
                .lword     DUMMY        ;DMA1 interrupt vector
                .lword     DUMMY        ;KEY interrupt vector
                .lword     DUMMY        ;A-D interrupt vector
                .lword     DUMMY        ;UART2 transmit/NACK interrupt vector
                .lword     DUMMY        ;UART2 receive/ACK interrupt vector
                .lword     DUMMY        ;UART0 transmit/NACK interrupt vector
                .lword     DUMMY        ;UART0 receive/ACK interrupt vector
                .lword     DUMMY        ;UART1 transmit/NACK interrupt vector
```

```
                .lword      DUMMY       ;UART1 receive/ACK interrupt vector
                .lword      DUMMY       ;TA0 interrupt vector
                .lword      DUMMY       ;TA1 interrupt vector
                .lword      DUMMY       ;TA2 interrupt vector
                .lword      DUMMY       ;TA3 interrupt vector
                .lword      DUMMY       ;TA4 interrupt vector
                .lword      TB0_INT     ;TB0 interrupt vector
                .lword      DUMMY       ;TB1 interrupt vector
                .lword      DUMMY       ;TB2 interrupt vector
                .lword      DUMMY       ;INT0 interrupt vector
                .lword      DUMMY       ;INT1 interrupt vector
                .lword      DUMMY       ;INT2 interrupt vector
;
;*******************************************************************************
;       Setting of fixed vector
;*******************************************************************************
;
                .section    f_vect,romdata
                .org        FIXED_VECT_TOP
;
                .lword      DUMMY       ;Undefined instruction interrupt vector
                .lword      DUMMY       ;Overflow (INTO instruction) interrupt vector
                .lword      DUMMY       ;BRK instruction interrupt vector
                .lword      DUMMY       ;Address match interrupt vector
                .lword      DUMMY       ;Single-step interrupt vector
                .lword      DUMMY       ;Watchdog timer interrupt vector
                                        ;Oscillation stop and Re-oscillation detection interrupt
                                        ;vector
                                        ;Voltage down detection interrupt vector
                .lword      DUMMY       ;DBC interrupt vector
                .lword      DUMMY       ;NMI interrupt vector
                .lword      START       ;Sets start vector
;
                .end
```

6. Referense

Hardware manual
M16C/62P Group Hardware Manual
(Use the most recent version of the document on the Renesas Technology Web site.)

Technical news/Technical update
(Use the most recent version of the document on the Renesas Technology Web site.)

Web-site and contact for support

Renesas Technology Web site
http://www.renesas.com/en/m16c

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Revision

Rev.	Issue data	Revised	
		Page	Point
1.00	2004.12	-	First edition issued
1.10	2006.01	5	Reference program modified

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